



MAIL STOP  
AMENDMENT

1FW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Takayuki Haze Attorney Docket No.: LEPA122745  
Application No.: 10/823,297 Art Unit: 2822 / Confirmation No: 4560  
Filed: April 13, 2004 Examiner: P.E. Perkins  
Title: METHOD OF FORMING BUMP PAD OF FLIP CHIP AND STRUCTURE THEREOF

RESPONSE TO RESTRICTION REQUIREMENT

January 3, 2006

TO THE COMMISSIONER FOR PATENTS:

The Office Action of December 6, 2005, has required an election between:

Group I, Claims 1-6, drawn to a method of forming a bump pad, classified in class 438, subclass 617; and

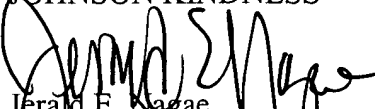
Group II, Claims 7-9, drawn to a bump pad, classified in class 257, subclass 737.

Applicant elects, without prejudice, for prosecution on the merits Group I, Claims 1-6.

If the Examiner has any questions concerning the foregoing, she is requested to contact the undersigned at the below indicated telephone number.

Respectfully submitted,

CHRISTENSEN O'CONNOR  
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I hereby certify that this correspondence is being deposited with the U.S. Postal Service in a sealed envelope as first class mail with postage thereon fully prepaid and addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the below date.

Date: 1/3/06

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